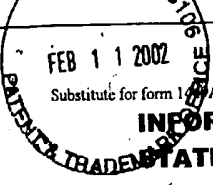


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<div style="text-align: center;">  <p>INFORMATION DISCLOSURE STATEMENT BY APPLICANT (use as many sheets as necessary)</p> </div>				COMPLETE IF KNOWN	
				Application Number	09/875,365
				Confirmation Number	8844
				Filing Date	06/05/2001
				First Named Inventor	Daniel J. Woodruff et al.
				Group Art Unit	1741
Examiner Name					
Sheet	1	of	1	Attorney Docket No.	29195.8156US

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*EXAMINER INITIALS	Cite No.	U.S. Patent Document		Name of Patentee or Applicant of Cited Document	Date of Publication of Cited Document	Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear
		NUMBER	Kind Code (if known)			
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		Office	Number	Kind Code (if known)				
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*EXAMINER INITIALS	Cite No.	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume/issue number(s), publisher, city and/or country where published.	T

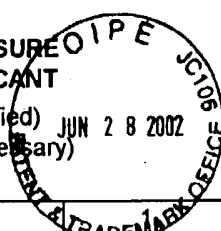
EXAMINER

William Leader

DATE CONSIDERED

6/15/2004

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INFORMATION DISCLOSURE STATEMENT BY APPLICANT Form PTO-1449 (Modified) (Use several sheets if necessary)			COMPLETE IF KNOWN	
			Application Number	09/875,365
			Confirmation Number	8844
			Filing Date	June 5, 2001
			First Named Inventor	Daniel J. Woodruff
			Group Art Unit	1741
			Examiner Name	Unknown
			Attorney Docket No.	291958156US
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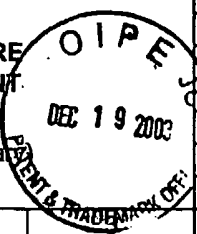
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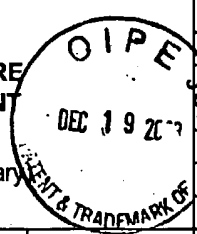
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			Application Number	09/875,365	
			Confirmation Number	8844	
			Filing Date	June 5, 2001	
			First Named Inventor	Daniel J. Woodruff	
			Group Art Unit	1742	
Examiner Name	William T. Leader				
Attorney Docket No.	291958156US				
Sheet	1	of	3		

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			First Named Inventor	Daniel J. Woodruff	
			Group Art Unit	1742	
			Examiner Name	William T. Leader	
			Attorney Docket No.	291958156US	
Sheet	2	of			

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				Examiner Name	William T. Leader
Sheet	3	of	3	Attorney Docket No.	291958156US

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		Office	NUMBER	Kind Code (if known)				
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